

Title (en)

STEEL PLATE MANUFACTURING EQUIPMENT AND METHOD OF MANUFACTURING

Title (de)

AUSRÜSTUNG ZUR HERSTELLUNG EINER STAHLPLATTE UND HERSTELLUNGSVERFAHREN

Title (fr)

EQUIPEMENT ET PROCÉDÉ DE FABRICATION DE PLAQUE D'ACIER

Publication

**EP 2412455 A4 20130529 (EN)**

Application

**EP 10756268 A 20100323**

Priority

- JP 2010055497 W 20100323
- JP 2009073994 A 20090325
- JP 2010006722 A 20100115

Abstract (en)

[origin: EP2412455A1] A facility is provided for manufacturing a steel plate excellent in steel plate shape and mechanical property while setting low cooling-water spraying performance in a descaling step and achieving uniform cooling in a cooling step. Specifically, a hot rolling mill 3, a first hot leveler 5, a descaler 4, and cooling equipment 6 are arranged in that order from the upstream side in a conveying direction. A pressure P [MPa] at the point of impact of cooling water sprayed from the descaler to each surface of a steel plate 1 is greater than or equal to 1.5 MPa.

IPC 8 full level

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CPC (source: EP KR US)

**B21B 39/00** (2013.01 - KR); **B21B 45/02** (2013.01 - KR); **B21B 45/08** (2013.01 - EP KR US); **B21B 39/08** (2013.01 - EP US); **B21B 45/0218** (2013.01 - EP US)

Citation (search report)

- [Y] JP 3796133 B2 20060712
- [Y] JP H10113713 A 19980506 - KOBE STEEL LTD
- [Y] JP 2004066308 A 20040304 - JFE STEEL KK

Cited by

EP3187275A4; EP3195946A4; EP4066956A4; EP2979770A4; WO2014023753A1; EP2882542B1

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